

# SPECIFICATION AGM 2002A-206

Atualizado em 05/06/19



## MODLE NO:

AGM 2002A-206

## DOC. FIRST ISSUE

## **RECORDS OF REVISION**

VERSION	DATE	REVISED PAGE NO.		SUMMARY
0	2007/01/16		Fi	rst issue
A	2008/10/23			odify Character
			G	enerator ROM Pattern
В	2012/09/03		Co	orrect ST7066IC
			in	formation.
C	2013/07/08		Re	emove IC information

## **Contents**

- 1.Precautions in use of LCD Modules
- 2.General Specification
- 3. Absolute Maximum Ratings
- 4. Electrical Characteristics
- 5. Optical Characteristics
- 6.Interface Pin Function
- 7. Contour Drawing & Block Diagram
- 8. Character Generator ROM Pattern
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

## 1.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and cleanenvironment.
- (8) AGT have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) AGT have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise ofnot affecting the electrical characteristics and external dimensions, AGT have the right to modify the version.)

# **2.General Specification**

Item	Dimension	Unit				
Number of Characters	20 characters x 2Lines	_				
Module dimension	116.0 x 37.0 x 13.9 (MAX)	mm				
View area	85.0 x 18.6	mm				
Active area	73.5x 11.5	mm				
Dot size	0.60 x 0.65	mm				
Dot pitch	0.65 x 0.70	mm				
Character size	3.20 x 5.55	mm				
Character pitch	3.70 x 5.95	mm				
LCD type	STN Positive, Yellow Green Transflective (In LCD production, It will occur slightly color can only guarantee the same color in the same by					
Duty	1/16					
View direction	6 o'clock					
Backlight Type	LED, Yellow Green					
IC	ST7066U					

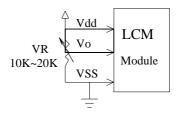
# **3.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{\mathrm{OP}}$	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V <sub>I</sub>	$V_{SS}$	_	$V_{DD}$	V
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	-0.3	_	7	V
Supply Voltage For LCD	$V_{DD}$ - $V_{o}$	-0.3	_	13	V

## **4. Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20°C	_	_	5.7	V
*Note	$V_{DD}$ - $V_0$	Ta=25°℃	4.2	4.35	4.5	V
		Ta=70°C	3.8	_	_	V
Input High Volt.	$V_{IH}$	_	0.7 V <sub>DD</sub>	_	$V_{DD}$	V
Input Low Volt.	$V_{\mathrm{IL}}$	_	Vss	_	0.6	V
Output High Volt.	$V_{\mathrm{OH}}$	_	3.9	_	$V_{\mathrm{DD}}$	V
Output Low Volt.	V <sub>OL</sub>	_	0	_	0.4	V
Supply Current	$I_{DD}$	V <sub>DD</sub> =5.0V	1.0	1.2	1.5	mA

<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board

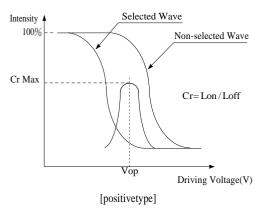


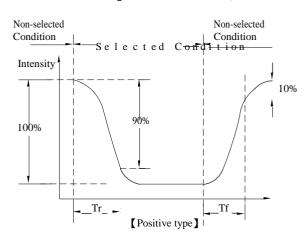
## **5.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\psi = 180^{\circ}$
Wiene Apple	θ	CR≧2	0	_	40	$\Psi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	ψ = 90°
	θ	CR≧2	0	_	30	$\psi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
D T'	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

#### **Definition of Operation Voltage (Vop)**

#### **Definition of Response Time (Tr, Tf)**





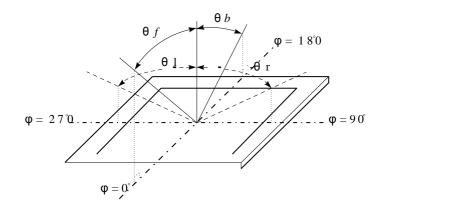
#### **Conditions:**

Operating Voltage: Vop Frame Frequency: 64 HZ

Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Driving Waveform: 1/N duty, 1/a bias

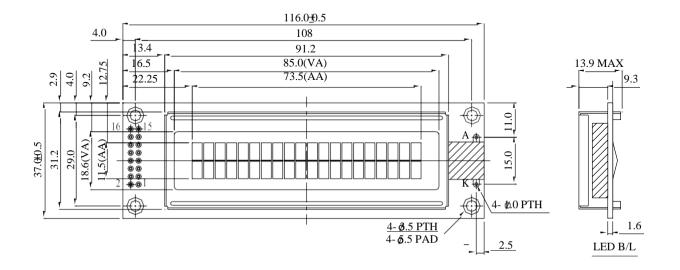
### Definition of viewing angle $(CR \ge 2)$



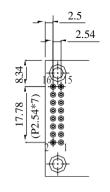
## **6.Interface Pin Function**

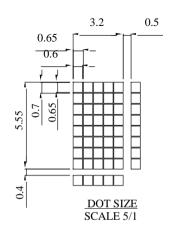
Pin No.	Symbol	Level	Description
1	$V_{SS}$	0V	Ground
2	$V_{\mathrm{DD}}$	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	Е	Н,Н→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	A	_	Power supply for B/L +
16	K	_	Power supply for B/L -

## 7. Contour Drawing & Block Diagram

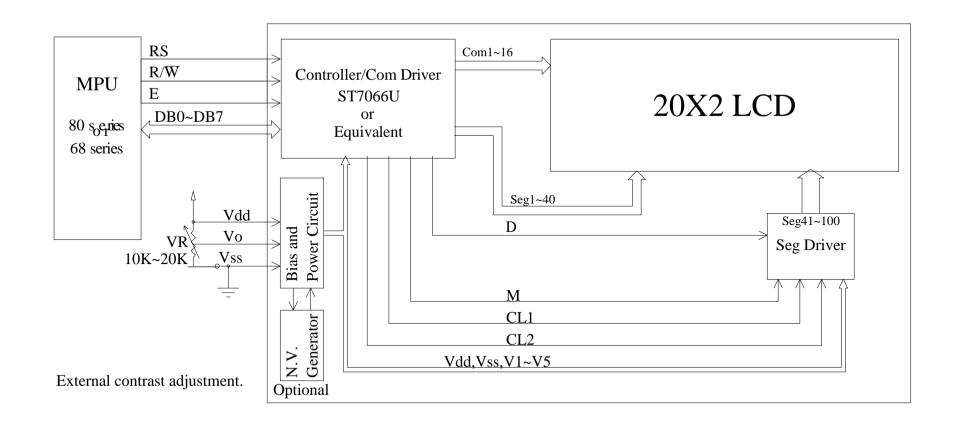


PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RS
5	R/W
6	Е
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	A
16	K





The non-specified tolerance of dimension is 0.3mm.



Character located 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20

DDRAM address 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F 10 11 12 13

DDRAM address 40 41 42 43 44 45 46 47 48 49 4A 4B 4C 4D 4E 4F 50 51 52 53

## **8. Character Generator ROM Pattern**

Table.2

Upper									1							
4 bit	LLLL	LLLH L	LHL LI	HH LHI	LL LHLI	   LHHL	LHHH 1	HLLL HL	LH HLF	IL HLH	H HHLI	HHLH	  HHHL	HHHH		
4 bit																
LLLL	CG RAM (1)			**************************************	\$ \$5\$\$\$ \$ \$5\$\$ \$ \$5\$\$ \$ \$5\$\$	4444444 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	5 5	55555 5 5				*****	5555 5 5 5 5 55 55	555 555 555	444 4 4 4 4 4 4 4 4	dhididhidhid G G G G Ghi
LLLH	(2)		व वस्तित	P P P P P P P P P P P P P P P P P P P	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$		555 5555 5555	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$			555 55 55 55	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	555 555 5555 5	\$ \$ \$ \$\$\$\$\$\$	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	child C C C C C C Characatar
LLHL	(3)		444	\$ \$ \$ \$	44444 4 4 4 4 4 4 4 4 44 44	444444 44 44 44 44 44 44 44 44	55555 55555 55555 55555	4444			<b>5</b> \$ \$	4444 4444	age	4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	##### #### #### #### #####	dddd g g g g g g g g g
LLHH	(4)		ያ የሚያ ያ የሚያ የሚያ	######################################	444 4 4 4 4 4		444	\$ \$\$\$			*5	다라다 다 다 다 다 다 다	**************************************	5 55555 55555	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	ዜ ያ የ ሜ
LHLL	(5)		**************************************	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	\$5 \$5 \$5 \$5 \$5 \$5 \$5	\$ \$\$\$ \$	**************************************			**************************************	#5 T	*2	**************************************	* *	***
LHLH	(6)					P. P. P.	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	555 555			<del>5</del>	**************************************	44444	######################################	denderten	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
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LHHL	(7)		25 5 5 5 5 5	55 5 5		4444	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	<b>5 5</b>			66666 6 66666	14444 4 4 4 4444	555	20002 20002 20002 20002	44 444 444	75 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5
LHHH	(8)				44 446 4 4	144 4	44 44 44 44				*******************	***********	*************************************	25 25 25 25 25 25 25 25 25 25 25 25 25 2	P P P	18 18 18 18 18 18 18 18 18 18 18 18 18 1
	(1)		- 54	#2 #2 #2	\$ \$5\$ \$ \$		\$ 50 \$ 50 \$ 50 \$ 50 \$ 50 \$ 50 \$ 50 \$ 50	# # # # # # # # # # # # # # # # # # #			1000	888888 8 8	* * * * * * * * * * * * * * * * * * *	***	200 A	de de la company
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			10 10 10 10 10 10 10 10 10 10 10 10 10 1	**************************************		10 10 10 10 10 10 10 10 10 10 10 10 10 1	\$ \$ \$ \$ \$ \$	**************************************			55 <u>555</u> 5 5 55555	**************************************	- B	\$ \$ \$ \$ \$ \$	d defendence defendence	4444
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			- 5-5 - 5-5 - 5-5	5 5 5 5 5	55 55 55 55 55 55 55 55 55 55	5555	5555 5 5 5 5 5 5	5 5 5 5 5 5			10 10 10 10 10 10 10 10 10 10 10 10 10 1	5 55 5 55 5 55	55555 5 5 5	55 55 55 55 55 55	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	CARARARAR CARARARARA CARARARARA CARARARAR

## 9. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	<b>Environmental Test</b>		
Test Item	Content of Test	<b>Test Condition</b>	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

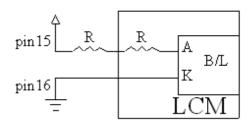
## **10. Backlight Information**

#### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION		
Supply Current	ILED	168	210	252	mA	V=4.2V		
Supply Voltage	v	4.0	4.2	4.4	V	-		
Reverse Voltage	VR	-	-	8	V	-		
Luminance (Without LCD)	IV	210	260	-	CD/M <sup>2</sup>	ILED=210mA		
Wave Length	λp	568	570	574	nm	ILED=210mA		
Life Time	-	-	100000	-	Hr.	ILED≦210mA 25°C,50-60%RH		
Color	Yellow Green							

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

2.Drive from pin15,pin16



(Will never get Vee output from pin15)

# 11.Inspection specification

NO	Item	Criterion				AQL	
01	Electrical Testing  Black or white spots on	Missing vertical, horizontal segment, segment contrast defect.  Missing character, dot or icon.  Display malfunction.  No function or no display.  Current consumption exceeds product specifications.  LCD viewing angle defect.  Mixed product types.  Contrast defect.  2.1 White and black spots on display ≤0.25mm, no more than					
02	LCD (display only)	three white or b 2.2 Densely spa	-	-	or lines within 3mm	2.5	
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi=(x+y)/2$ 3.2 Line type:	As follow Length	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense  2 1 0  Acceptable Q TY Acceptable Q TY Accept no dense  2 As round type	2.5	
04	Polarizer bubbles	If bubbles are v judge using bla specifications, i to find, must ch specify directio	ck spot not easy neck in	Size $\Phi$ $\Phi \le 0.20 \ 0.20$ $< \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5	

NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD bla	ack spots, white spots, c	ontamination	
		Symbols Define:			
		x: Chip length	y: Chip width z: C	Chip thickness	
		k: Seal width	t: Glass thickness a: L	CD side length	
		L: Electrode pad leng	th:		
		6.1 General glass chip	):		
		6.1.1 Chip on panel su	urface and crack betwee	n panels:	
				HAR STATE OF THE S	
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≤1/2t	Not over viewing	x≤1/8a	
06	Chipped		area		2.5
	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x ≤ 1/8a	
		6.1.2 Corner crack: $z$ : Chip thickness $z \le 1/2t$	y: Chip width  Not over viewing	x: Chip length x≤1/8a	
		$  \sum 1/2t$	_	X ≦ 1/8a	
		1/2	area	(1/0	
		$1/2t < z \le 2t$	Not exceed 1/3k	$x \le 1/8a$	
		on there are 2 or mo	re chips, x is the total le	ngm of each emp.	

NO	Item	Criterion			AQL
		Symbols: x: Chip length y: Chip k: Seal width t: Glass L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	thickness a: LCD	o thickness O side length	
		y: Chip width $x: C$ $y \le 0.5 \text{mm}$ $x \le 2$ $6.2.2 \text{ Non-conductive portion}$		$z$ : Chip thickness $0 < z \le t$	
06	Glass	y X	Z y	1 2 X	2.5
		y: Chip width	x: Chip length	z: Chip thickness	
			x ≤ 1/8a	$0 < z \le t$	
		⊙ If the chipped area touches remain and be inspected acco			
		⊙ If the product will be heat sealed by the customer, the alignment mark not			
		be damaged. 6.2.3 Substrate protuberance and internal crack.			
		X	y: width	x: length	
			y≤1/3L	$x \leq a$	
		y A			
L	<u> </u>	753927			l

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	
		8.1 Illumination source flickers when lit.	
08	Backlight	8.2 Spots or scratched that appear when lit must be judged.	
	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints,	
09		stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
	PCB、COB	10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10		10.6 Parts on PCB must be the same as on the production	0.65
10		characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
		X X X X X X X X X X X X X X X X X X X	
		X * Y<=2mm2	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
11		11.2 No cold solder joints, missing solder connections,	2.5
	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
12		12.3 No contamination, solder residue or solder balls on product	
		12.4 The IC on the TCP may not be damaged, circuits.	
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	126 The residual rosin or tin oil of soldering (component or chip	2.5
		component) is not burned into brown or black color.	
	appearance	127 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

# **12. Material List of Components for RoHs**

1. AGTECHNOLOGIES PRODUTOS ELETRONICOS, Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS						

Above limited value is set up according to RoHS.

#### 2. Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. : Reflow :  $250^{\circ}$ C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp.  $: 235\pm5^{\circ}C$ ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

## 13.Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.